

FMI13N60E

Super FAP-E³ series

N-CHANNEL SILICON POWER MOSFET

Features

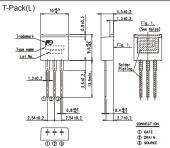
Maintains both low power loss and low noise Lower R_{DS}(on) characteristic More controllable switching dv/dt by gate resistance Smaller VGS ringing waveform during switching Narrow band of the gate threshold voltage (3.0±0.5V) High avalanche durability

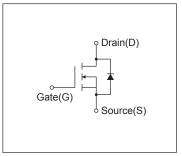
Applications

Switching regulators UPS (Uninterruptible Power Supply) **DC-DC converters**

Outline Drawings [mm]

Equivalent circuit schematic





Maximum Ratings and Characteristics

Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks	
Durin Course Valéana	VDS	600	V		
Drain-Source Voltage	VDSX	600	V	V _{GS} = -30V	
Continuous Drain Current	lo	±13	А		
Pulsed Drain Current	IDP	±52	А		
Gate-Source Voltage	Vgs	±30	V		
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	13	А	Note*1	
Non-Repetitive Maximum Avalanche Energy	Eas	471.5	mJ	Note*2	
Repetitive Maximum Avalanche Energy	Ear	22.5	mJ	Note*3	
Peak Diode Recovery dV/dt	dV/dt	5.2	kV/µs	Note*4	
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note*5	
Maximum Power Dissipation	PD	1.67	W	Ta=25°C	
		225	VV	Tc=25°C	
On susting and Stanson Temporature reason	Tch	150	°C		
Operating and Storage Temperature range	Tstg	-55 to + 150	°C		

Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BVDSS	I _D =250μA, V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	Vgs (th)	ID=250µA, VDS=VGS	ID=250µA, VDS=VGS		3.0	3.5	V
Zero Gate Voltage Drain Current		V _{DS} =600V, V _{GS} =0V	Tch=25°C	-	-	25	μA
	IDSS	V _{DS} =480V, V _{GS} =0V	Tch=125°C	-	-	250	
Gate-Source Leakage Current	Igss	V _{GS} =±30V, V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	RDS (ON)	ID=6.5A, VGS=10V		-	0.50	0.58	Ω
Forward Transconductance	g _{fs}	ID=6.5A, VDS=25V		7.5	15	-	S
Input Capacitance	Ciss	V _{DS} =25V		-	2150	3225	
Output Capacitance	Coss	V _{GS} =0V f=1MHz		-	190	285	pF
Reverse Transfer Capacitance	Crss			-	14	21	
Turn-On Time td(on)		V _{cc} =300V		-	21	31.5	
tr	tr	V _{GS} =10V I _D =6.5A R _{GS} =10Ω		-	8	12	ns
Turn-Ott Time	td(off)			-	100	150	
	tf			-	15	22.5	
Total Gate Charge	QG	Vcc=300V - 60 Ip=13A - 17 Vcs=10V - 18		-	60	90	nC
Gate-Source Charge	QGS			-	17	25.5	
Gate-Drain Charge	QGD			27			
Avalanche Capability	lav	L=2.36mH, Tch=25°C		13	-	-	A
Diode Forward On-Voltage	Vsd	IF=13A, VGS=0V, Tch=25°C		-	0.90	1.08	V
Reverse Recovery Time	trr	I⊧=13A, V₀s=0V -di/dt=100A/µs, Tch=25°C		-	0.7	-	μs
Reverse Recovery Charge	Qrr			-	8	-	μC

Thermal Characteristics

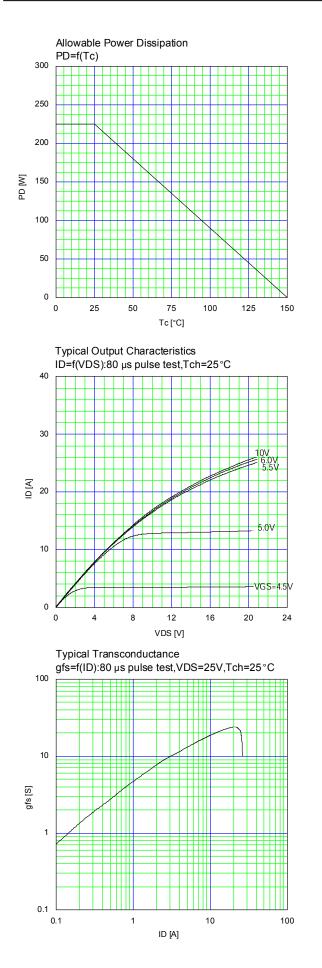
Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to case			0.560	°C/W
	Rth (ch-a)	Channel to ambient			75.0	°C/W

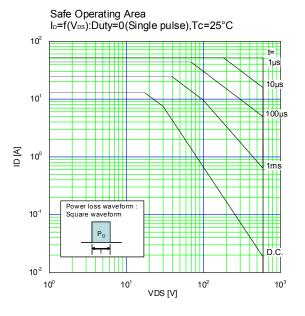
Note *1 : Tch≤150°C

Note *2 : Stating Tch=25°C, IAS=6A, L=24.0mH, Vcc=60V, RG=50Ω Eas limited by maximum channel temperature and avalanche current. See to 'Avalanche Energy' graph. Note *3 : Repetitive rating : Pulse width limited by maximum channel temperature.

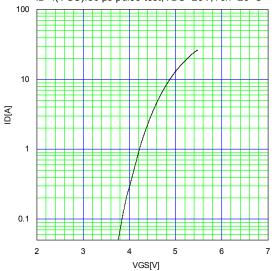
See to the 'Transient Themal impeadance' graph

Note *4 : IF≤-ID, -di/dt=100A/µs, Vcc≤BVDss, Tch≤150°C. Note *5 : IF≤-ID, dv/dt=5.2kV/µs, Vcc≤BVDss, Tch≤150°C.

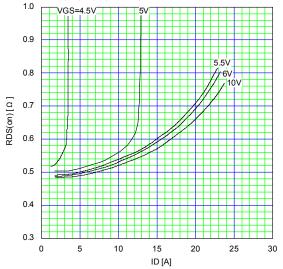


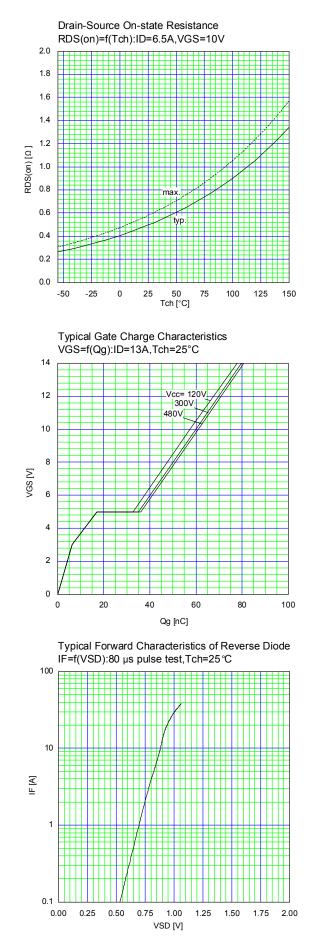


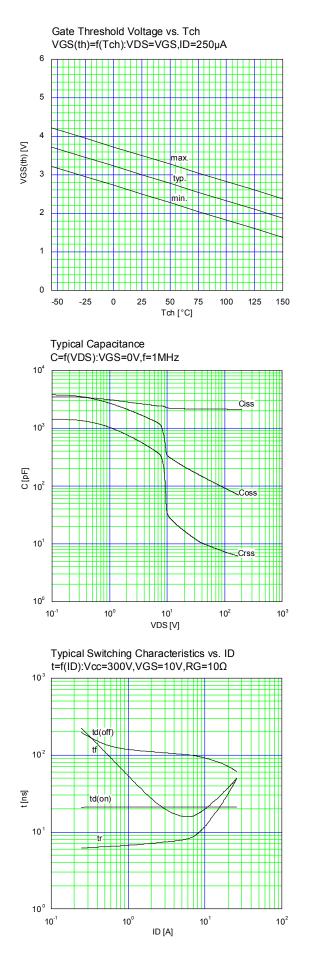
Typical Transfer Characteristic ID=f(VGS):80 µs pulse test,VDS=25V,Tch=25°C

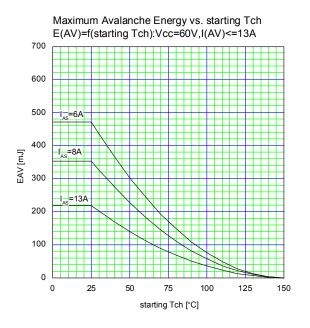


Typical Drain-Source on-state Resistance RDS(on)=f(ID):80 µs pulse test, Tch=25 °C

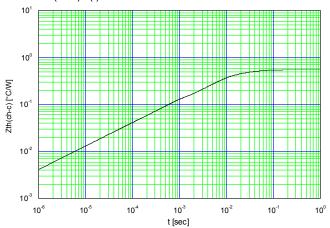








Maximum Transient Thermal Impedance Zth(ch-c)=f(t):D=0



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